

Ceramic Resonators, Chip Type (3 Array Type)

- Type: **EFO**
- Type: **EFOB**
- Type: **EFOSS**
- Type: **EFOSM**
- Type: **EFOBM**
- Type: **EFOJM**
- Type: **EFOST**



■ Features

- Encased in a ceramic package
- High reliability against soldering heat and mechanical stress
- Moisture-proof sealing
- 1.2 mm maximum (SS/SM/BM/JM), 0.8 mm maximum (ST) in thickness
- Designed for reflow soldering
- Flat-bottom plate for better mountings
- Simplifies oscillation circuits by reducing the number of circuit parts
- RoHS compliant

■ Recommended Applications

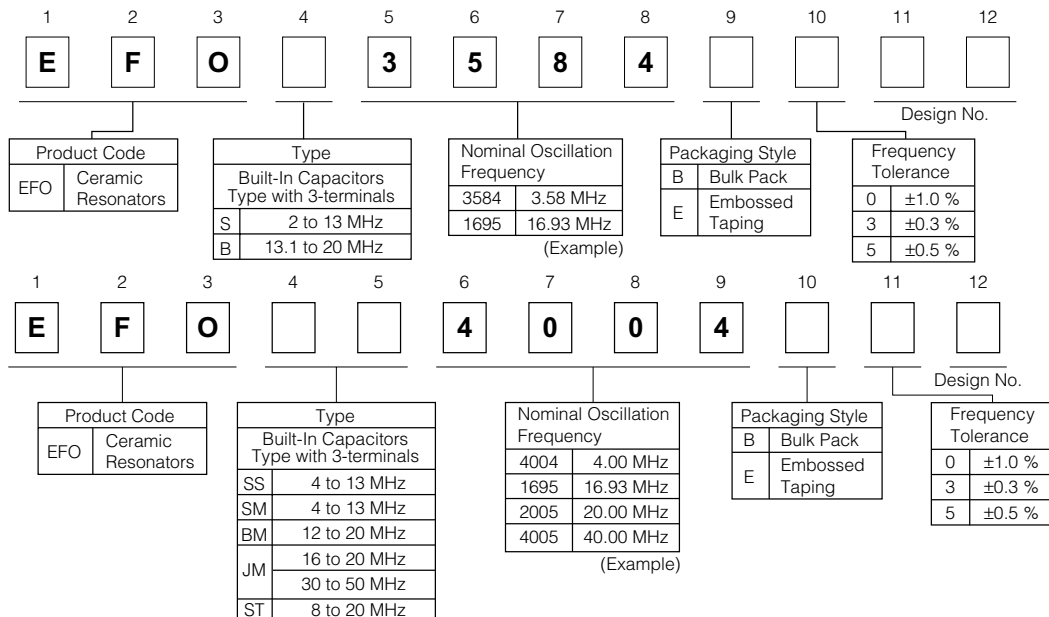
- Clock generator for microprocessors
- Carrier circuit between telecommunication equipment (Telephone to telephone, personal computer to printer)

■ Handling Precautions (See Page 175 to 176)

■ Packaging Specifications

See Page 169 to 177

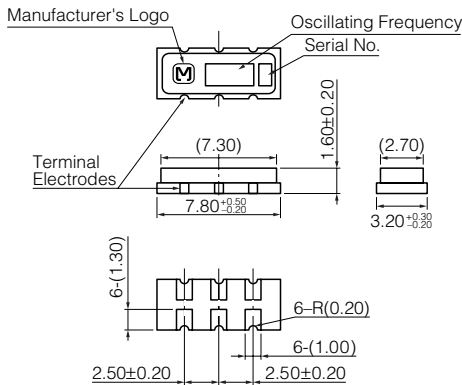
■ Explanation of Part Numbers



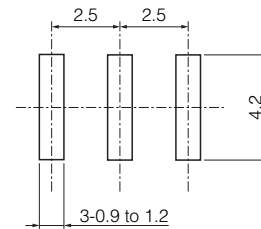
Part Number	Frequency range (MHz)	Frequency Temperature Characteristics (-20 to +80 °C)	Built-in Capacitors (Reference)
EFO	2.00 to 8.39	±0.2 %	33 pF
	8.40 to 13.0	±1.0 %	
EFOB	13.1 to 20.0	±0.5 %	33 pF
	4.00 to 8.39	±0.2 %	
EFOSS	8.40 to 13.0	±0.3 %	21 pF
	4.00 to 8.39	±0.2 %	
EFOSM	8.40 to 13.0	±1.0 %	33 pF
	12.0 to 20.0	±0.3 %	
EFOBM	16.0 to 20.0	±0.5 %	18 pF
	30.0 to 50.0	±0.2 %	
EFOJM	8.00 to 12.9	±0.2 %	10 pF
	13.0 to 20.0	±0.5 %	

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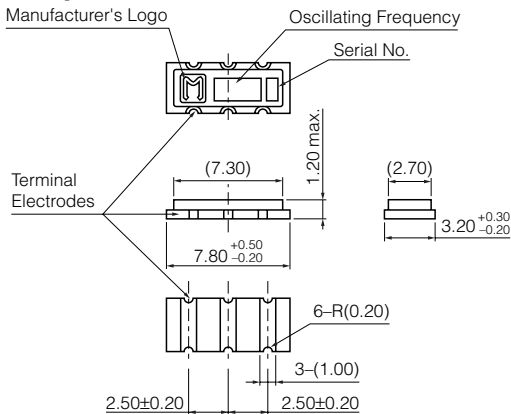
■ Dimensions in mm (not to scale)
 Recommended Land Dimensions
 [Type EFOS].....2.0 to 13.0 MHz



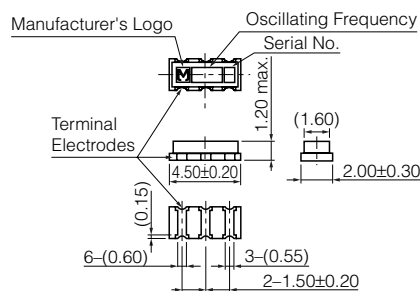
[Type EFOS, EFOSM]



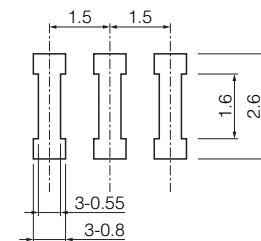
[Type EFOSM].....4.0 to 13.0 MHz



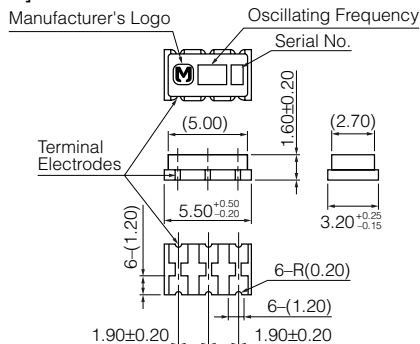
[Type EFOSS].....4.0 to 13.0 MHz



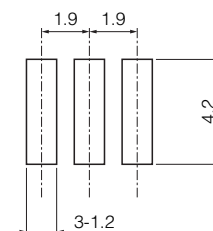
[Type EFOSS]



[Type EFOB].....13.1 to 20.0 MHz



[Type EFOB]

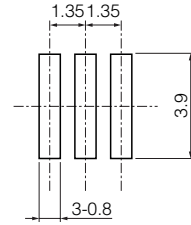
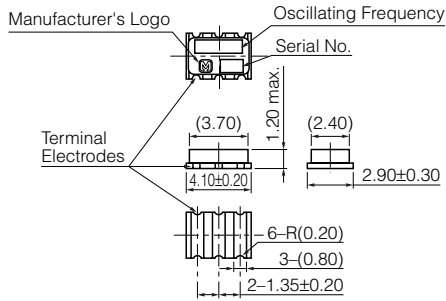


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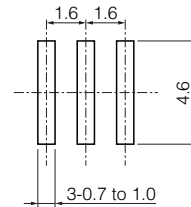
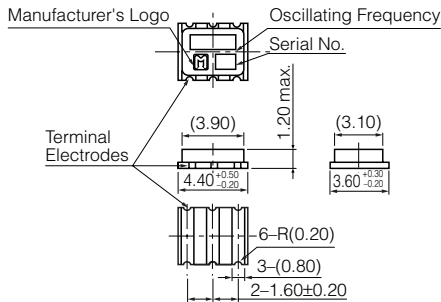
■ Dimensions in mm (not to scale)
Recommended Land Dimensions
 [Type EFOBM].....12.0 to 20.0 MHz

[Type EFOBM]



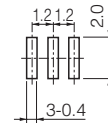
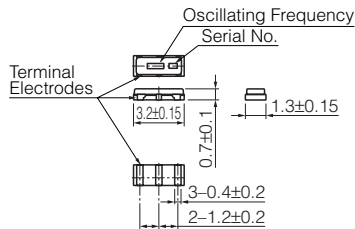
[Type EFOJM].....16.0 to 20.0, 30.0 to 50.0 MHz

[Type EFOJM]

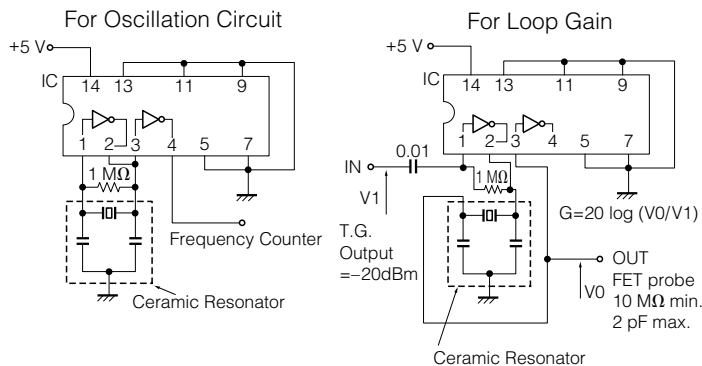


[Type EFOST].....8.00 to 20.0 MHz

[Type EFOST]



■ Test Circuits Diagram



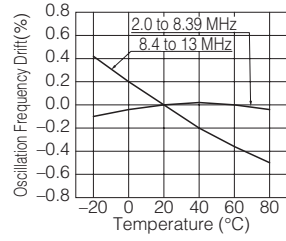
Type	Frequency	IC
Excluding ST	2.00 to 8.39 MHz	μPD4069UBC, TC4069UBP or similar
	8.40 to 50.0 MHz	μPD74HCU, TC74 HCU04AP or similar
ST	8.00 to 12.9 MHz	μPD4069UBC, TC4069UBP or similar
	13.0 to 20.0 MHz	μPD74HCU, TC74 HCU04AP or similar

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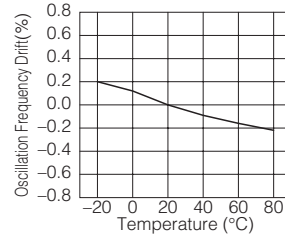
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Typical Characteristics Temperature Characteristics

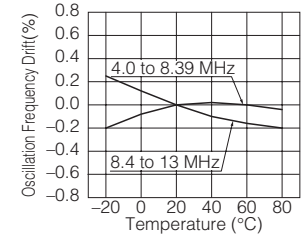
Type EFOS



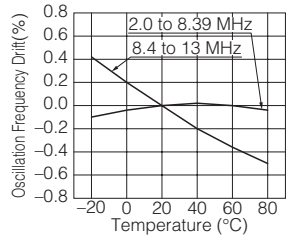
Type EFOB



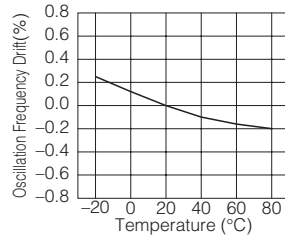
Type EFOSS



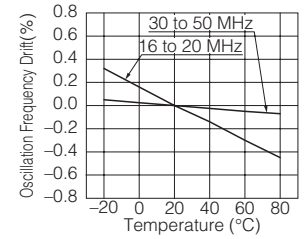
Type EFOSM



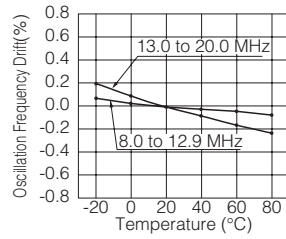
Type EFOBM



Type EFOJM



Type EFOST



Packaging Specifications

Standard Packing Quantity

Type	Embossed Taping	Bulk
EFOS, EFOSM	2500 pcs./reel	500 pcs./bag
EFOSS	2000 pcs./reel	
EFOB, EFOBM, EFOJM	1000 pcs./reel	
EFOST	3000 pcs./reel	

[Type EFOS, EFOSM]

Dim. (mm)	ϕA	ϕB	C	D	E
	330 \pm 5	80 min.	13.0 \pm 0.5	21.0 \pm 0.8	2.0 \pm 0.5

Dim. (mm)	W	T	t	r
	16.4 $^{+2.0}_0$	22.4 max.	3 max.	1.0

[Type EFOSS, EFOB, EFOBM, EFOJM]

Dim. (mm)	ϕA	ϕB	C	D	E
	180 \pm 5	60 min.	13.0 \pm 0.5	21.0 \pm 0.8	2.0 \pm 0.5

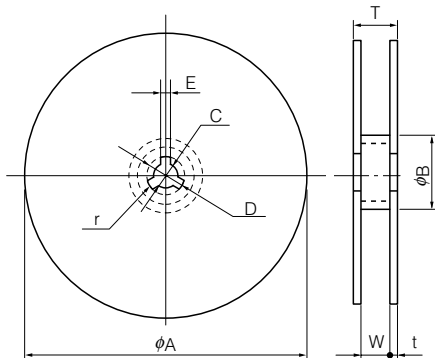
Dim. (mm)	W	T	t	r
	12.4 $^{+2.0}_0$	18.4 max.	3 max.	1.0

[Type EFOST]

Dim. (mm)	ϕA	ϕB	C	D	E
	180 \pm 5	60 min.	13.0 \pm 0.2	ϕ 21.0 \pm 0.8	2.0 \pm 0.5

Dim. (mm)	W	T	t	r
	8.4 $^{+2.0}_0$	14.0 max.	2.5 max.	1.0

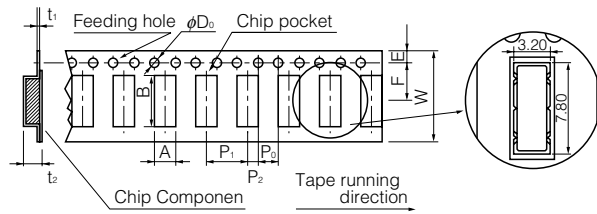
Dimensions for Reel in mm (not to scale)



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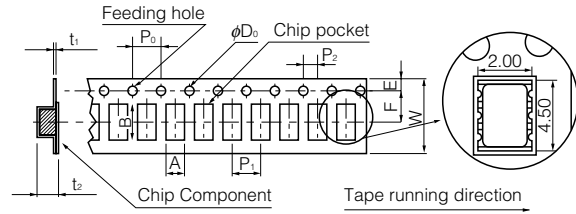
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[Type EFOS, EFOSM]



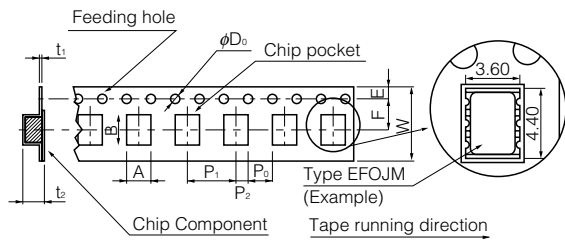
Dim. (mm)	A	B	W	F	E	P ₁
	3.7±0.2	8.3±0.2	16.0±0.3	7.5±0.1	1.75±0.10	8.0±0.1
Dim. (mm)	P ₂	P ₀	φD ₀	t ₁	t ₂	
	2.0±0.1	4.0±0.1	1.5 ^{+0.1} ₀	0.3	3.5 max.	

[Type EFOSS]



Dim. (mm)	A	B	W	F	E	P ₁
	2.6±0.2	5.1±0.2	12.0±0.3	5.5±0.1	1.75±0.10	4.0±0.1
Dim. (mm)	P ₂	P ₀	φD ₀	t ₁	t ₂	
	2.0±0.1	4.0±0.1	1.5 ^{+0.1} ₀	0.6 max.	3.0 max.	

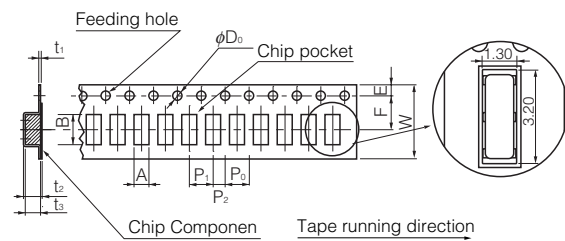
[Type EFOB, EFOBM, EFOJM]



Dim. (mm)	A	B	W	F	E	P ₁
	①	②	12.0±0.3	5.5±0.1	1.75±0.10	8.0±0.1
Dim. (mm)	P ₂	P ₀	φD ₀	t ₁	t ₂	
	2.0±0.1	4.0±0.1	1.5 ^{+0.1} ₀	0.6 max.	3.0 max.	

Dim. (mm)	A	B
	①	②
Type EFOB	3.7±0.2	6.0±0.2
Type EFOBM	3.4±0.2	4.6±0.2
Type EFOJM	4.1±0.2	4.9±0.2

[Type EFOST]



Dim. (mm)	A	B	W	F	E	P ₁
	1.5±0.2	3.4±0.2	8.0±0.2	3.5±0.1	1.75±0.10	4.0±0.1
Dim. (mm)	P ₂	P ₀	φD ₀	t ₁	t ₂	t ₃
	2.0±0.1	4.0±0.1	1.5 ^{+0.1} ₀	0.35	2.0 max.	(8.0)